

# Paul H. Lee

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## EDUCATION

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### The Loomis Chaffee School

Windsor, CT  
May 2015

### Villanova University

*Bachelor of Science in Mathematics, Minor in Computer Science*

Villanova, PA  
May 2019

- GPA: 3.5 / 4.0
- Robert C. Dunn Scholar

## WORK EXPERIENCE

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### The Mall of Korea

Business Analyst

Bangkok, Thailand

July 2017 – August 2017

- Gathered and parsed data using Python and “BeautifulSoup,” further analyzing it using Excel
- Developed a WAMP webserver for proper data management and easier access

### Big Apple Greeter

Intern

New York, NY

June 2016 - July 2017

- Conducted comprehensive database management using SQL to normalize the “Post-Visit” database.
- Redesigned the “Neighborhood Profiles” using Adobe InDesign

### Skimm’bassador

Brand Ambassador

New York, NY

July 2017-

### KudoSociety

Barista

Palisades Park, NJ

June 2016 - July 2016

## ACADEMICS

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### Mergers & Acquisitions

Member

Villanova, PA

March 2016-

- Observed and learned through both actual financial scenarios and formal education in the world of deal making and mergers and acquisitions.

### World Financial Group

Student

Englewood Cliffs, NJ

June 2017-

- Certified NJ Life Producer and attended weekly webinars focusing on “Financial Foundations”

### Independent Researcher

Researcher

New York, NY

June 2015 – August 2016

- Conducted research on Roman Archaeology and Roman Philosophy. Submitted and accepted to the following conferences: Classical Association Annual Conference, ATINER Conference on History & Archaeology, and the SIFG: III International Conference of Greek Philosophy

## SKILLS, ACTIVITIES & INTERESTS

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**Languages:** Fluent in English; Conversational Proficiency in Korean

**Technical Skills:** SQL, Java, Python, MS Access

**Activities:** Corporate Finance Society, Special Olympics, Wall Street Society, Phi Sigma Kappa

**Interests:** Basketball, Photography, and Technology